

STW90NF20

N-channel 200 V, 0.019 Ω, 83 A, TO-247 low gate charge STripFET™ Power MOSFET

Features

Туре	V _{DSS}	R _{DS(on)} max	I _D
STW90NF20	200 V	< 0.023 Ω	83 A

- Exceptional dv/dt capability
- Low gate charge
- 100% Avalanche tested

Application

■ Switching applications

Description

This Power MOSFET series realized with STMicroelectronics unique STripFET™ process has specifically been designed to minimize input capacitance and gate charge. It is therefore suitable as primary switch in advanced higherficiency isolated DC-DC converters

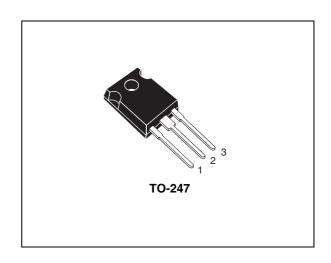


Figure 1. Internal schematic diagram

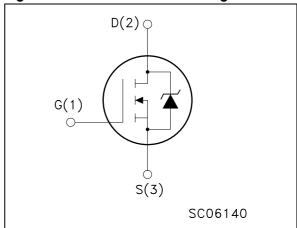


Table 1. Device summary

Order code	Marking	Package	Packaging
STW90NF20	90NF20	TO-247	Tube

Contents STW90NF20

Contents

1	Electrical ratings	3
2	Electrical characteristics	4
	2.1 Electrical characteristics (curves)	6
3	Test circuits	8
4	Package mechanical data	9
5	Revision history1	1

STW90NF20 Electrical ratings

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage (V _{GS} = 0)	200	V
V _{GS}	Gate-source voltage	± 20	V
I _D	Drain current (continuous) at T _C = 25 °C	83	Α
I _D	Drain current (continuous) at T _C = 100 °C	52	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	332	Α
	Derating factor	2.4	W/°C
P _{TOT}	Total dissipation at T _C = 25 °C	300	W
dv/dt (2)	Peak diode recovery voltage slope	15	V/ns
T _J Tstg	Operating junction temperature Storage temperature -50 to 150		°C

^{1.} Pulse width limited by safe operating area

Table 2. Thermal resistance

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	0.42	°C/W
R _{thj-amb}	Thermal resistance junction-ambient max	50	°C/W
T _I	Maximum lead temperature for soldering purpose	300	°C

Table 3. Avalanche characteristics

Symbol	Parameter	Max value	Unit
I _{AR}	Avalanche current, repetitive or not-repetitive (pulse width limited by T_J max)	83	Α
E _{AS}	Single pulse avalanche energy (starting $T_J = 25$ °C, $I_D = I_{AR}$, $V_{DD} = 50$ V)	400	mJ

^{2.} $I_{SD} \leq$ 83 A, di/dt \leq 400 A/ μ s, $V_{DD} \leq$ 80% $V_{(BR)DSS}$

Electrical characteristics STW90NF20

2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 1 mA, V _{GS} = 0	200			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V_{DS} = Max rating, V_{DS} = Max rating @125 °C			1 10	μ Α μ Α
I _{GSS}	Gate body leakage current (V _{DS} = 0)	V _{DS} = ± 20 V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	3	4	V
R _{DS(on)}	Static drain-source on resistance	V _{GS} = 10 V, I _D = 45 A		0.018	0.023	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
9 _{fs} ⁽¹⁾	Forward transconductance	$V_{DS} = 15 V_{,} I_{D} = 45 A$		40		S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse Transfer Capacitance	$V_{DS} = 25 \text{ V, f} = 1 \text{ MHz,}$ $V_{GS} = 0$		5736 1126 196		pF pF pF
C _{oss eq.} ⁽²⁾	Equivalent output capacitance	$V_{DS} = 0$ to 160 V, $V_{GS} = 0$		687		pF
R_{G}	Intrinsic gate resistance	f = 1 MHz open drain		1.7		Ω
$egin{array}{c} Q_{g} \ Q_{gs} \ Q_{gd} \end{array}$	Total gate charge Gate-source charge Gate-drain charge	V_{DD} = 160 V, I_{D} = 83 A, V_{GS} = 10 V (see Figure 15)		164 46 72		nC nC nC

^{1.} Pulsed: pulse duration = 300µs, duty cycle 1.5%

^{2.} $C_{oss\ eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$t_{ m d(on)} \ t_{ m r} \ t_{ m d(off)} \ t_{ m f}$	Turn-on delay time Rise time Turn-off delay time Fall time	$V_{DD} = 100 \text{ V}, I_{D} = 41.5 \text{ A}$ $R_{G} = 4.7 \Omega, V_{GS} = 10 \text{ V},$ (see Figure 14)		24 138 148 142		ns ns ns ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current Source-drain current (pulsed)				83 332	A A
V _{SD} ⁽²⁾	Forward on voltage	$I_{SD} = 83 \text{ A}, V_{GS} = 0$			1.6	٧
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 83 \text{ A}, V_{DD} = 100 \text{ V}$ di/dt = 100 A/ μ s (see Figure 19)		200 1.6 16		ns μC A
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} =83 A, V_{DD} = 100 V di/dt = 100 A/µs T_j = 150°C (see Figure 19)		235 2.2 18		ns μC Α

^{1.} Pulse with limited by maximum temperature

^{2.} Pulsed: pulse duration = 300µs, duty cycle 1.5%

Electrical characteristics STW90NF20

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

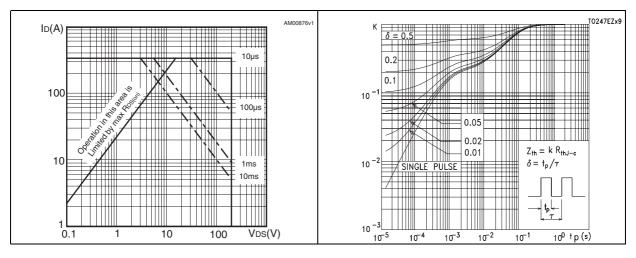


Figure 4. Output characteristics

Figure 5. Transfer characteristics

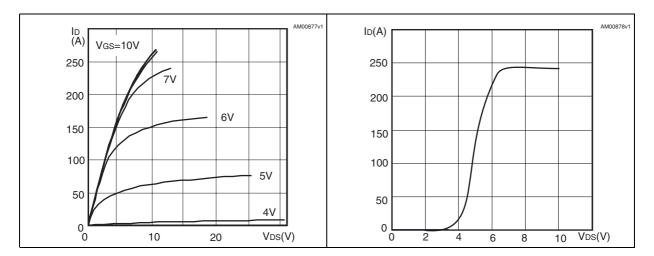
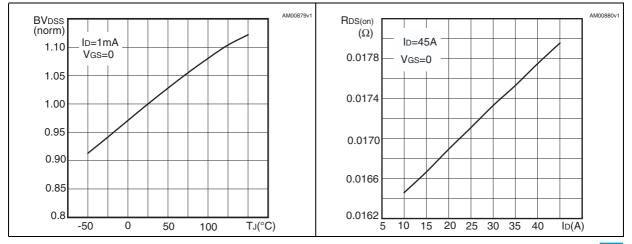


Figure 6. Normalized BV_{DSS} vs temperature Figure 7. Static drain-source on resistance



5//

Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

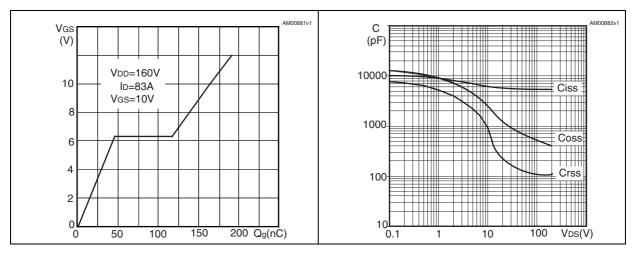


Figure 10. Normalized gate threshold voltage Figure 11. Normalized on resistance vs vs temperature temperature

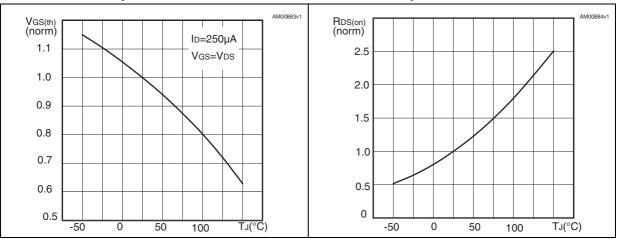
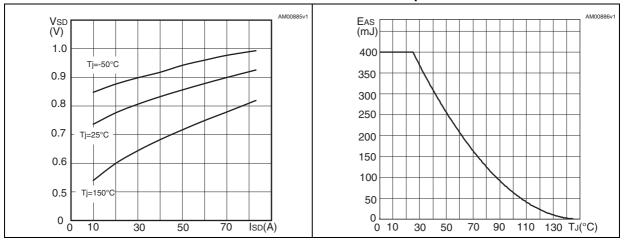


Figure 12. Source-drain diode forward characteristics

Figure 13. Maximum avalanche energy vs temperature



577

Test circuits STW90NF20

3 Test circuits

Figure 14. Switching times test circuit for resistive load

Figure 15. Gate charge test circuit

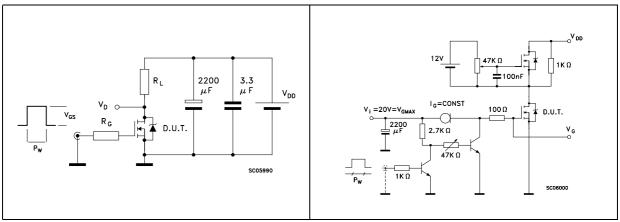


Figure 16. Test circuit for inductive load switching and diode recovery times

Figure 17. Unclamped inductive load test circuit

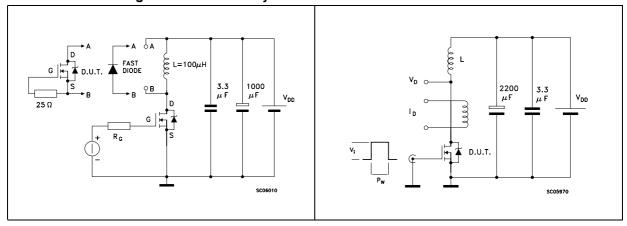
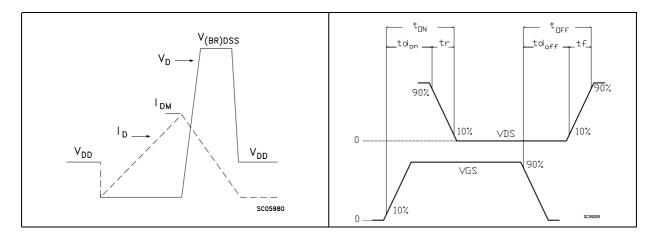


Figure 18. Unclamped inductive waveform

Figure 19. Switching time waveform



577

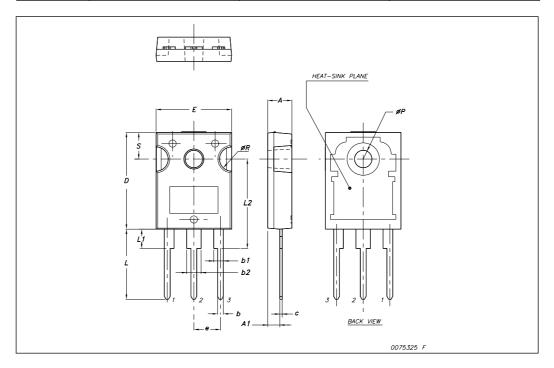
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

9/12

TO-247 Mechanical data

Dim.	mm.			
Dilli.	Min.	Тур	Max.	
Α	4.85		5.15	
A1	2.20		2.60	
b	1.0		1.40	
b1	2.0		2.40	
b2	3.0		3.40	
С	0.40		0.80	
D	19.85		20.15	
Е	15.45		15.75	
е		5.45		
L	14.20		14.80	
L1	3.70		4.30	
L2		18.50		
øΡ	3.55		3.65	
øR	4.50		5.50	
S		5.50		



STW90NF20 Revision history

5 Revision history

Table 8. Document revision history

Date	Revision	Changes
28-Aug-2007	1	First release
04-Aug-2008	2	Document status promoted from preliminary data to datasheet.

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577